





#### **DUAL SURFACE MOUNT LOW LEAKAGE DIODE**

#### **Features**

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)

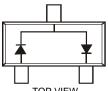
### **Mechanical Data**

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)





TOP VIEW



TOP VIEW Internal Schematic

## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	85	V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	60	V	
Forward Continuous Current (Note 2)	Single diode Double diode	I <sub>FM</sub>	160 140	mA	
Repetitive Peak Forward Current (Note 2)		I <sub>FRM</sub>	500	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0 0.5	А	

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	$P_{D}$	250	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	$T_J,T_STG$	-65 to +150	°C

## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	85	_	_	V	$I_R = 100 \mu A$
Forward Voltage	V <sub>F</sub>	_	_	0.90 1.0 1.1 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 1)	I <sub>R</sub>	_	_	5.0 80	nA nA	V <sub>R</sub> = 75V V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C
Total Capacitance	C <sub>T</sub>	_	2	_	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	_	3.0	μS	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

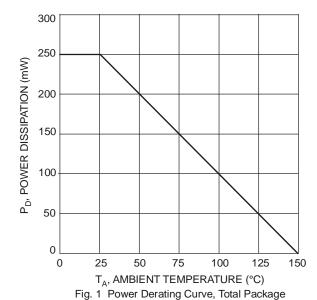
Notes:

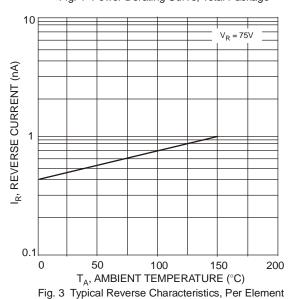
- 1. Short duration pulse test used to minimize self-heating effect.
- 2. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

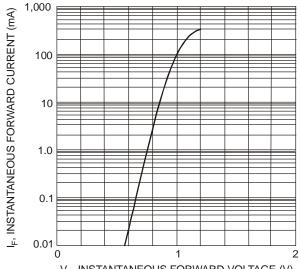
May 2008

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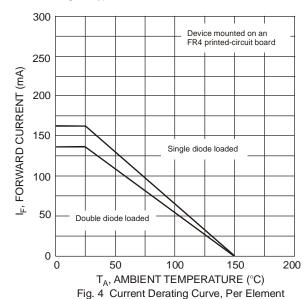








V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics, Per Element



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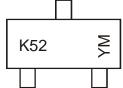
# Ordering Information (Note 5)

Part Number	Case	Packaging		
BAV199-7-F	SOT-23	3000/Tape & Reel		

Notes:

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



K52 = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002

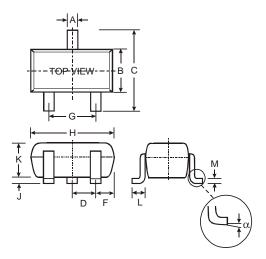
M = Month ex: 9 = September

Date	Code	Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	J	<b>V</b>	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	0	2	4	E	6	7	Ω	0		N	D

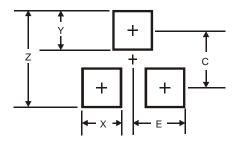


## **Package Outline Dimensions**



SOT-23				
Dim	Min	Max		
Α	0.37	0.51		
В	1.20	1.40		
С	2.30	2.50		
D	0.89	1.03		
F	0.45	0.60		
G	1.78	2.05		
Н	2.80	3.00		
J	0.013	0.10		
K	0.903	1.10		
L	0.45	0.61		
M	0.085	0.180		
α	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35

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